

KEY FEATURES

- ° Intel® 14th Gen Core™ Processors with H610 Chipset
- ° 2 x 262-pin DDR5 SO-DIMM up to 96GB (48GB per DIMM)
- * 1 x PCle x16 (Up to PCle Gen5) or 2 x PCle x8 (Up to PCle Gen5)
- * 1 x M.2 Key M, 2 x M.2 Key B, 1 x M.2 Key E
- * 4 x USB 3.2 Gen2x1, 2 x USB 2.0 Gen2x1, 6 x COM, 4 x SATA3, 8 x DI, 8 x DO
- * 5 x Intel 2.5G LAN (2 support PoE, 1 supports vPro)
- * 1 x Displayport, 1 x HDMI 2.0b, 1 x VGA
- * Powerful Edge AI acceleration enabled by the most flexible mechanical, thermal, and power design, with support for 275mm \times 124 mm \times 60 mm (L \times H \times D) max. and up to 600W graphic card

SPECIFICATIONS

Processor System

CPU	Intel® 14th Gen Core™ Processors
Chipset	Intel® H610
Socket	LGA 1700

Memory

Technology	Dual Channel DDR5 5600MHz
Capacity	96 GB (48GB per DIMM)
Socket	2 x 262-pin SO-DIMM

Graphics

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Controller	Intel® UHD Graphics
DisplayPort	DisplayPort 1.4a , DP++
	Max resolution up to 4096x2160@60Hz
HDMI	HDMI 2.0b
	Max resolution up to 4096x2160@60Hz
VGA	Max resolution up to 1920x1200@60Hz

Audio

Interface	Realtek ALC897, High Definition Audio.

Preliminary

Expansion Slot

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PCle	1 x PCle Gen5 x16 (single x16 or dual x8), PCle x16 slot with default power cable can support up to 180W graphic card (275mm x 111.15 mm x 60 mm (L x H x D), if remove the card holder, it can be limited on 275mm x 124mm x 60 mm) Graphic card can be up to 600W with optional VGA module 1 x PCle Gen5 x8 (shared with dual x8)
RF& Antenna	8 x SMA connector hole reserved
M.2	1 x M.2 (Key E, 2230) with CNVI/PCIe Gen3 x1 and USB2.0 for Wi-Fi/BT module 1 x M.2 (Key B1, 2280/3042/3052) with PCIe Gen3 x1 / USB3.2 Gen1x1 and USB2.0 for 4G / 5G 1 x M.2 (Key B2, 3042/3052) with PCIe Gen3 x1 / USB3.2 Gen1x1 and USB2.0 for 4G / 5G
SIM Socket	2 x Nano SIM Card slot (2 connected to M.2 Key B)

Ethernet

Controller/ Speed	2 x Intel® i226IT (1 vPro Support)
	2 x Intel® i226IT (PoE Support, each port supports IEEE 802.3AT PoE,
	PoE output max. 30W/single port or 30W/two ports shared)
Connector	5 x RJ45

Storage

M.2	1 x M.2 (Key M, 2242/2280/22110/25110) with Gen3 x4 for NVMe SSD
SATA	4×SATA3 (6Gb/s), support RAID 0/1/5/10 4×2.5" HDD/SSD Tray
CFast (Option)	1 x Type II socket (Shared with SATA3)

Front I/O

DisplayPort	1
HDMI	1
VGA	1
Ethernet	5 x Intel 2.5G LAN
USB	4 x USB 3.2 Gen2x1, 2 x USB 2.0 Gen2x1,
	1 x USB2.0 internal connector w/ lock function
Audio	1 x Mic-in, 1 x Line-out
COM	4xRS232/422/485 (COM1, COM2- optional Card w/ Isolation
	Protection, COM5-Isolation Protection, COM6)
	2 x RS232 (COM3, COM4)
DIO	8Dls/8DOs

Watchdog Timer

Output	From Super I/O to drag RESETCON#
Interval	256 Segments, 0, 1, 2,255sec

Power Requirements

Input PWR	9V-36V VDC with Ignition control and remote power on/off switch. 80V Surge Protection, OVP, UVP, OCP and reverse protection Ignition Power Input w/ 13-mode condition
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Environment

Operating Temperature	35W CPU: -40°C~75°C (-40°F~167°F)
	46W~65W CPU: -40°C~55°C (-40°F~131°F)
	(with FAN inside, without Add-on Card) (w/ air flow 0.5~0.8 m/s)
Storage Temperature	-40°C~85°C (-40°F~185°F)
Humidity	~95% @ 40°C (non-condensing)
Shock	Operating: 50 G, half sine 11ms duration with SSD
Vibration	Operating: 5 Grms, 5-500 Hz, 3 axes with SSD
ESD	Contact +/-4kV, Air +/-8kV
EMC	EN61000-6-4/-2, CE & FCC Class A
Safety	LVD

Mechanical

Construction	Aluminum heatsink + Metal chassis
Mounting	Desk Mount
Dimensions	202mm (W) x 290mm (D) x 209.3mm (H) (7.95" x 11.42" x 8.24")
Net Weight	10kg

Others

OS Support	Windows 10 & Linux
TPM	TPM 2.0
Real-Time Enablement	TSN, TCC support under YOCTO